

Application Data Sheet

Application Information

Application number::

Filing Date::

Application Type:: Regular

Subject Matter:: Utility

Suggested classification::

Suggested Group Art Unit::

CD-ROM or CD-R??:

Number of CD disks::

Number of copies of CDs::

Sequence Submission::

Computer Readable Form (CRF)?:

Number of copies of CRF::

Title:: Polysilicon Layers Structure and Method of
Forming Same

Attorney Docket Number:: 00939A-085300US

Request for Early Publication:: No

Request for Non-Publication:: No

Suggested Drawing Figure::

Total Drawing Sheets:: 6

Small Entity?:: No

Latin name::

Variety denomination name::

Petition included?:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers One::

Secrecy Order in Parent Appl.: No

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: Taiwan
Status:: Full Capacity
Given Name:: Kai-Cheng
Middle Name::
Family Name:: Chou
Name Suffix::
City of Residence:: San Jose
State or Province of Residence:: CA
Country of Residence:: US
Street of Mailing Address:: 3661 Jasmine Circle
City of Mailing Address:: San Jose
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 95135

Correspondence Information

Correspondence Customer Number:: 20350

Representative Information

Representative Customer Number:: 20350

Assignee Information

Assignee Name:: Hynix Semiconductor, Inc.
Street of mailing address:: San 136-1, Ami-ri, Bubal-eub, Ich'on-si
City of mailing address:: Kyoungki-do, 467-701
State or Province of mailing address::
Country of mailing address:: Korea
Postal or Zip Code of mailing address::